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- Max $r_{DS(on)} = 2.4 \text{ m}\Omega \text{ at } V_{GS} = 10 \text{ V}, I_D = 26 \text{ A}$
- Max $r_{DS(on)} = 3.0 \text{ m}\Omega \text{ at } V_{GS} = 4.5 \text{ V}, I_D = 23 \text{ A}$
- Advanced Package and Silicon Combination for Low r_{DS(on)} and High Efficiency
- SyncFET Schottky Body Diode
- MSL1 Robust Package Design
- 100% UIL Tested
- RoHS Compliant

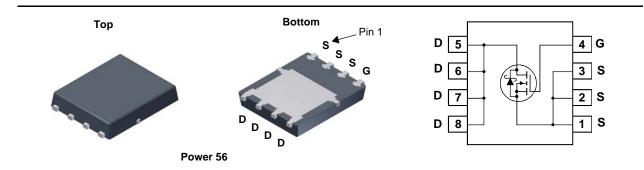


General Description

The FDMS0306AS has been designed to minimize losses in power conversion application. Advancements in both silicon and package technologies have been combined to offer the lowest $r_{\text{DS}(on)}$ while maintaining excellent switching performance.This device has the added benefit of an efficient monolithic Schottky body diode.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore/GPU Low Side Switch
- Networking Point of Load Low Side Switch
- Telecom Secondary Side Rectification



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
	Drain Current -Continuous (Package limited)	$T_C = 25^{\circ}C$		49		
	-Continuous (Silicon limited)	T _C = 25°C		128		
ID	-Continuous	$T_A = 25^{\circ}C$	(Note 1a)	26	Α	
	-Pulsed			100		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	86	mJ	
D	Power Dissipation	T _C = 25°C		59	W	
P _D	Power Dissipation	T _A = 25°C	(Note 1a)	2.5	VV	
T _J , T _{STG}	Operating and Storage Junction Temperature Ra	ange		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2.1	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note	e 1a) 50	0/00

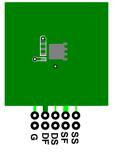
Package Marking and Ordering Information

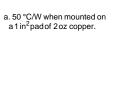
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS0306AS	FDMS0306AS	Power 56	13 "	12 mm	3000 units

				Тур.	Max.	Units	
JII Chara	cteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 1 mA, V _{GS} = 0 V	30		1	V	
BV _{DSSt}	Drain to Source Breakdown Voltage (transient)		34			V	
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 10 \text{ mA}$, referenced to 25°C		16		mV/°C	
DSS	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$			500	μA	
GSS	Gate to Source Leakage Current, Forward	$V_{GS} = 20 V, V_{DS} = 0 V$			100	nA	
On Chara	cteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1 \text{ mA}$	1.2	1.7	3.0	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 10$ mA, referenced to 25°C		-5		mV/°C	
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 26 A		2.0	2.4		
DS(on)		$V_{GS} = 4.5 V, I_{D} = 23 A$		2.6	3.0	mΩ	
		$V_{GS} = 10 V, I_D = 26 A, T_J = 125^{\circ}C$		2.7	3.3		
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 26 A$		168		S	
Dynamic (Characteristics						
C _{iss}	Input Capacitance			2670	3550	pF	
C _{oss}	Output Capacitance	V _{DS} = 15 V, V _{GS} = 0 V, f = 1MHz		975	1300	pF	
C _{rss}	Reverse Transfer Capacitance			95	140	pF	
R _g	Gate Resistance			0.7	2.5	Ω	
	Characteristics						
d(on)	Turn-On Delay Time			12	21	ns	
r	Rise Time	V _{DD} = 15 V, I _D = 26 A,		5	10	ns	
d(off)	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		32	52	ns	
f	Fall Time	1 1		4	10	ns	
Q _q	Total Gate Charge	V _{GS} = 0 V to 10 V		41	57	nC	
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 4.5 V V_{DD} = 15 V,$		20	28	nC	
Q _{gs}	Gate to Source Charge	I _D = 26 A		7.0		nC	
Q _{gd}	Gate to Drain "Miller" Charge	1 1		5.4		nC	

V _{SD}	Source-Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2 A$ (Note 2)	0.63	0.8	V
	Source-Drain Diode Forward voltage	$V_{GS} = 0 V, I_S = 26 A$ (Note 2)	0.8	1.2	
t _{rr}	Reverse Recovery Time	I _E = 26 A, di/dt = 300 A/μs	29	46	ns
Q _{rr}	Reverse Recovery Charge	$I_{\rm F} = 20$ A, u/u = 300 A/µs	32	51	nC
Notos:					

Notes: 1. R_{0JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.





b.125 °C/W when mounted on a minimum pad of 2 oz copper.

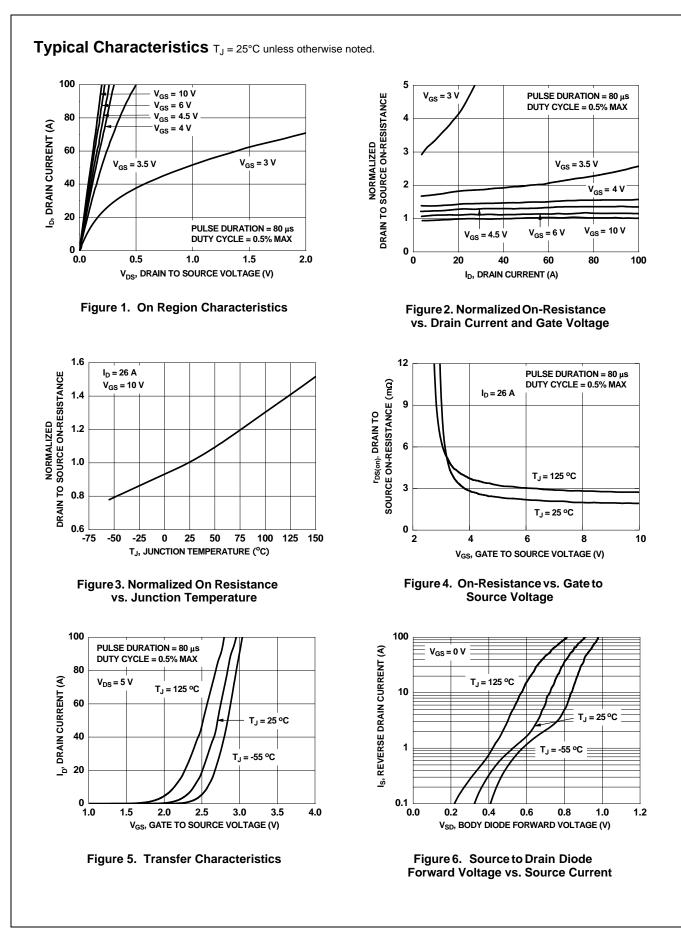
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. E_{AS} of 86 $\,$ mJ is based on starting T_J = 25 °C, L = 0.3 mH, I_{AS} = 24 A, V_{DD} = 27 V, V_{GS} = 10 V.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

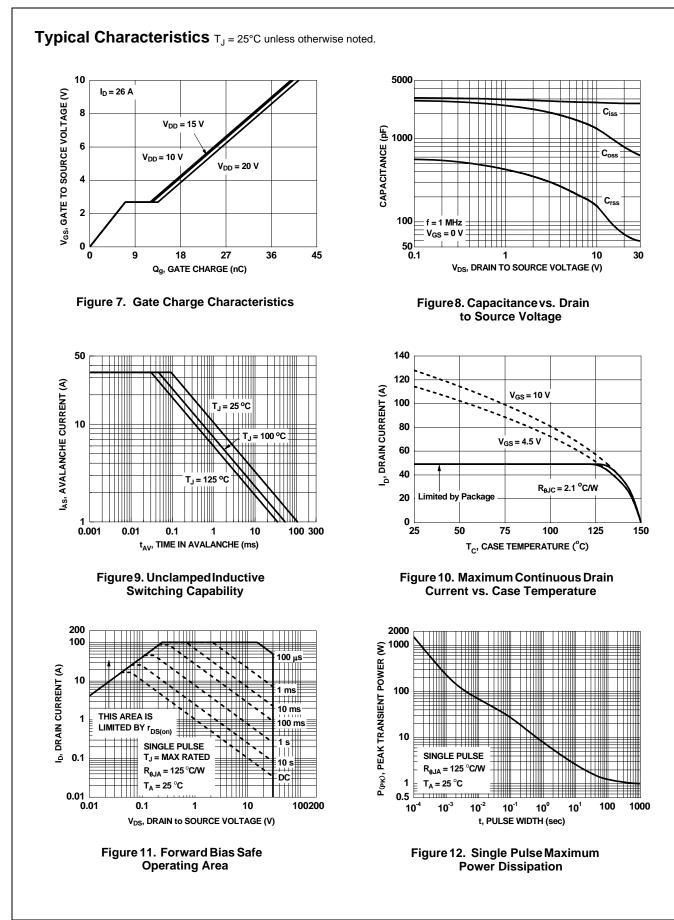
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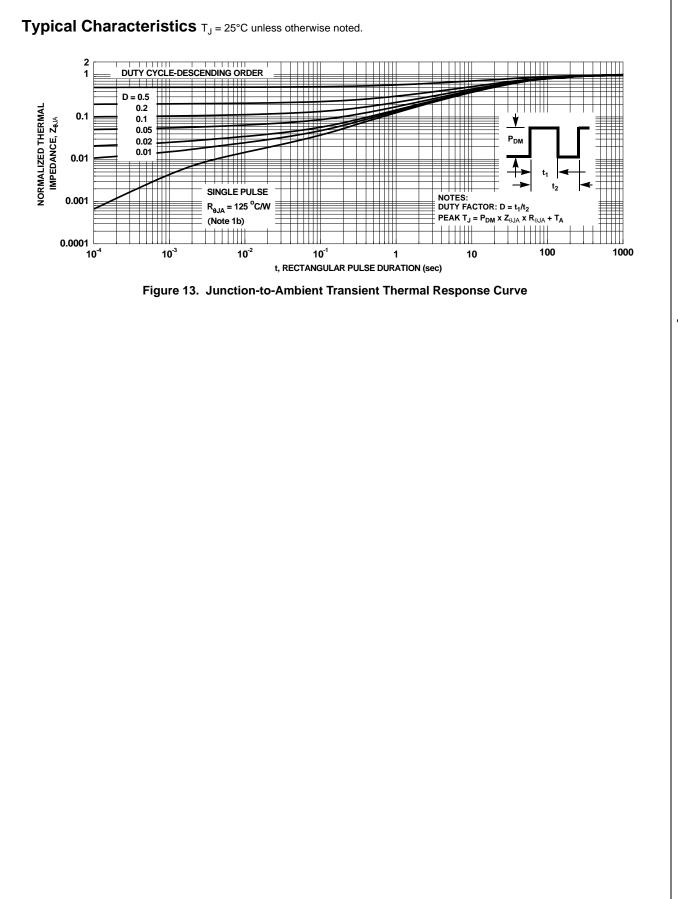
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Typical Characteristics (continued)

SyncFET Schottky Body Diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 14 shows the reverse recovery characteristic of the FDMS0306AS.

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

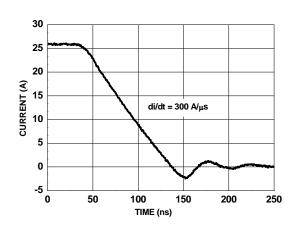
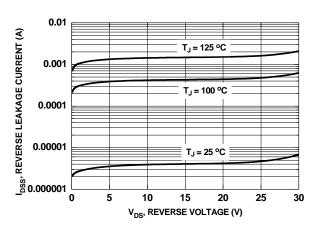
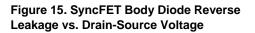


Figure 14. FDMS0306AS SyncFET Body Diode Reverse Recovery Characteristic







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